

The background of the slide is light gray. On the left side, there is a large, faint, stylized letter "N" in a light gray color. To the right of the "N", there is a cluster of white circles of varying sizes, arranged in a roughly triangular shape, similar to the one in the CeNSE logo but in white.

CLEANROOM ORIENTATION

CeNSE, NNFC

Entering to cleanroom

- Use biometric access for entering to NNFC (or IISc barcoded ID card, if available)



- Keep the footwear on the rack and wear the shoecover and cleanroom slipper



- Keep the cleanroom slipper on the rack



- Use biometric access and go inside the cleanroom entrance for airshower



Gowning Procedure

1) Wear **Facemask**



2) Wear **Hairnet**



3) Wear **Gown**



4) Wear **Shoe**



5) Wear **Gloves**



**Make sure that you
step on the sticky
mat before you enter
the cleanroom**

Wet etch area of Lithography for cleaning , spin coating and development process



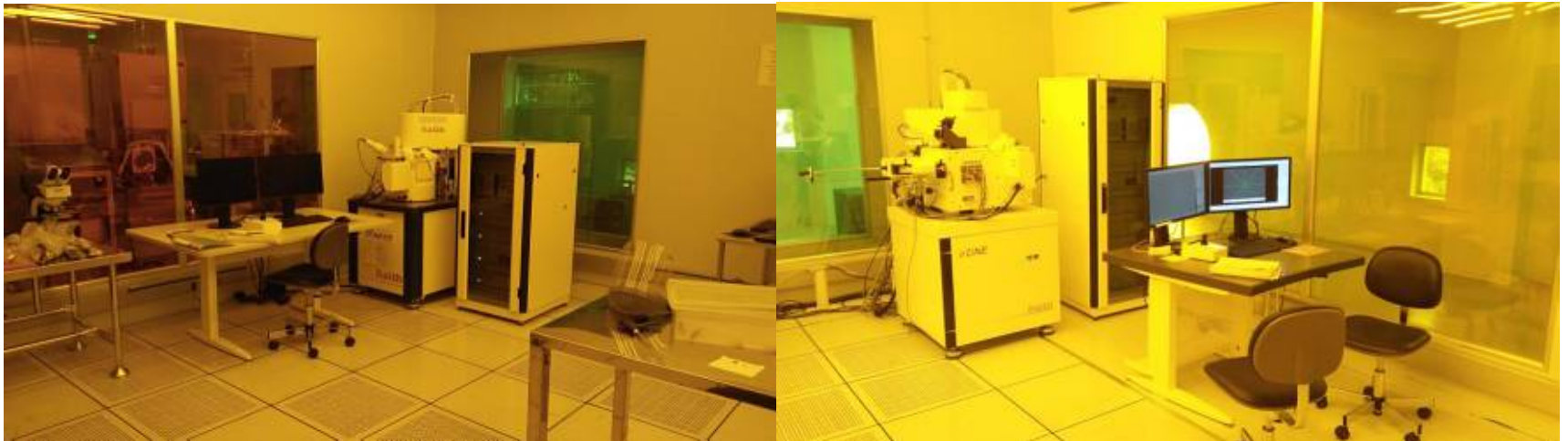
Optical litho wet etch area

E- beam litho wet etch area

Optical lithography bay



E- Beam lithography



In case of any emergency

❖ Evacuation route from Lithography bay



In case of any alarm

- ❖ Press EMO of the tool
- ❖ Evacuate from lithography immediately

Dry Etch

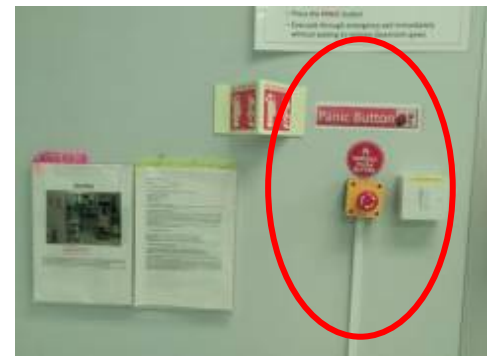


In case of a tool emergency (like presence of smoke)

1) Press **EMO** of the tool



2) Press **panic button**



3) Evacuate from dry etch by using fire exit and from nearest extension, inform BMS

❖ Evacuation route from Dry Etch



“ Your safety is our priority”



❖ Wear all the PPE before wet etch process

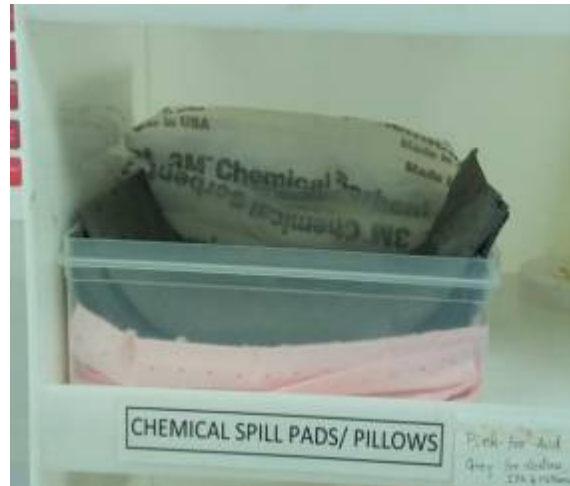


Safety measurements in wet etch

Safety shower and eye shower



Chemical spill pads/pillows



First aid box



MSDS sheet



Panic button

in case of major chemical spill

- ❖ Inform the other users in wet etch
- ❖ Evacuate immediately from wet etch
- ❖ Put the redtape which is kept infront of wet etch door
- ❖ Inform BMS (115) from the nearest extension phone



in case of minor chemical spill (less than 2ft wide and not HF)

- ❖ Cover the area by using acid spill pillows
- ❖ Dilute the chemical by using DI water
- ❖ Use pink colour absorbing pad for acids and use grey color absorbing pad for solvents
- ❖ Inform the FT/BMS

ALARMS INSIDE CLEANROOM



- 1) Alarm
- 2) Fire alarm
- 3&4) Plenum LEFT& RIGHT (smoke)
- 5) Below Raised floor (smoke)

NB: If any of alarms triggered evacuate from cleanroom immediately

If there is power a failure for more than 2 minutes evacuate from cleanroom

Diffusion

In case of any emergency

- ❖ Press the EMO of the tool



- ❖ Evacuate from diffusion



In case of gas leakage

- ❖ Evacuate immediately
- ❖ After evacuation, from nearest extension in the cleanroom corridor, **inform BMS(115)**



In case of any emergency

- ❖ Press EMO of the tool
- ❖ Evacuate immediately from the bay
- ❖ Panic buttons are available near the door

Evacuation route from Thinfilm



Inline characterisation



In case of any emergency

- ❖ Turn off the tool
- ❖ Evacuate from inline characterization

Evacuation route from Inline characterisation



Equipment development

High power laser is used here



If laser is on, the indicator will be on



If laser is on, wear the laser protection glass, then only enter to the bay



Evacuation route from Inline characterisation



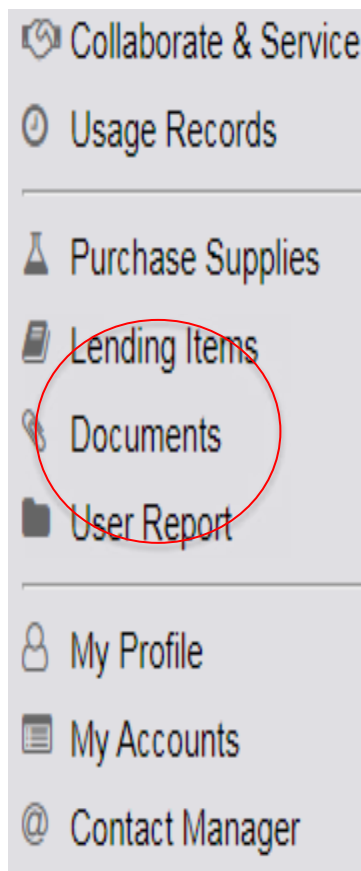
Degowning



- ❖ Remove Gloves
- ❖ Remove Shoe
- ❖ Remove Gown
- ❖ Remove Hairnet
- ❖ Remove Facemask

New user training on tools

- Training videos are available in user groups/ FOM
- FOM – Documents – Tool Training Video



- Training Video: <https://web.microsoftstream.com/video/2d7330d0-95ad-4a44-a41b-46aa7f42b180>
- Anelva RF Sputtering
 - Training Video Link: <https://web.microsoftstream.com/video/95d43039-5055-43fc-8315-13cb78ee2b3>
- Atomic Layer Deposition_Beneq
 - ALD Trend Chart Sept 2018: http://facilitybooking.cense.iisc.ernet.in/fom/downloadFile?fn=ALD_Sep
 - Standard Operating Procedure: [http://facilitybooking.cense.iisc.ernet.in/fom/downloadFile?fn=Standard Procedure\(ALD\) Ver 3_01032017.docx](http://facilitybooking.cense.iisc.ernet.in/fom/downloadFile?fn=Standard Procedure(ALD) Ver 3_01032017.docx)
 - Training Video: <https://web.microsoftstream.com/video/3751e46c-ba72-4daf-9501-14ada623b112>
- Chemical HF Vapouriser WB
 - SOP HFVPE.doc: <http://facilitybooking.cense.iisc.ernet.in/fom/downloadFile?fn=SOP HFVPE.doc>
- Chemical Wet bench (Solvents/bases) Level 3
 - Trend charts Wet Etch_August_2018: http://facilitybooking.cense.iisc.ernet.in/fom/downloadFile?fn=Etch_August_2018_5.pot
- Chemical wet bench Acid clean -Level 1
 - Trend charts Wet Etch_August_2018: http://facilitybooking.cense.iisc.ernet.in/fom/downloadFile?fn=Etch_August_2018_6.pot
 - Training video: <https://web.microsoftstream.com/video/36b458d8-1a47-4696-9b9c-177014dde999>
- Chemical wet bench Acid clean -Level 2

Joining User groups

“Discover groups” in Outlook email and request to join, Tool specific groups are

1. CPD and Tempres
2. Diffusion
3. Ebeam litho
4. In-line characterization
5. Leybold e-beam evaporator users group
6. NNFC ALD users group
7. NNFC Annexe users group
8. NNFC DRIE users group
9. NNFC PECVD users group
10. NNFC Optical Litho users group
11. NNFC RIE users group
12. Tecport E-beam Evaporator users group
13. Tecport Sputter coaters user group
14. Wet etch

Email respective Tool owners (FT's) for drive test

WORK SAFE

Thank you